502142799 11/28/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Daniele Vimercati	11/21/2012
Andrea Marmiroli	11/21/2012

RECEIVING PARTY DATA

Name:	Micron Technology, Inc.
Street Address:	8000 South Federal Way
Internal Address:	MS 525
City:	Boise
State/Country:	IDAHO
Postal Code:	83716

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13687706

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 400.807US01

NAME OF SUBMITTER: Daniel J. Polglaze

Total Attachments: 3

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> PATENT REEL: 029366 FRAME: 0491

OP \$40,00 13687706

ASSIGNMENT

WHEREAS, we, <u>Daniele Vimercati</u>, residing at <u>Via Ferrante Brioschi</u>, 31, <u>Besana in Brianza</u>, <u>MB</u>, <u>20842</u>, <u>Italy</u>, and <u>Andrea Marmiroli</u>, residing at <u>Via Savio</u>, 32, <u>Alzano Lombardo</u>, <u>BG</u>, <u>24022</u>, <u>Italy</u> made certain new and useful inventions and improvements for which we executed an application for Letters Patent of the United States herewith, and which is entitled <u>MATCHING SEMICONDUCTOR CIRCUITS</u>.

AND WHEREAS, <u>Micron Technology</u>, <u>Inc.</u>, a corporation organized and existing under and by virtue of the laws of the State of <u>Delaware</u>, and having an office and place of business at <u>8000 South Federal Way</u>, <u>MS 525</u>, <u>Boise</u>, <u>Idaho</u>, <u>83716</u>, (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, we have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, we do hereby agree that we and our respective executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore we covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me/us and that full right to convey the same as herein expressed is possessed by us.

PATENT REEL: 029366 FRAME: 0492 Docket No.: 400.807US01 Serial No.: Unknown Title: MATCHING SEMICONDUCTOR CIRCUITS

Micron Docket No. 2012-0098:00/US Filing Date: Herewith Page 2 of 3

IN TESTIMONY WHEREOF, I have hereunto set my hand this <u>21</u> day of <u>MONEMBOR</u>, 2012.

Daniele Vicue och'

WITNESS:	
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(Date) 22 6012	·
WITNESS:	<u> </u>
FEBERICO PIO	tedichi
Printed Name	Signature
November 22, 2012	a.
(Date)	

Docket No.: 400.807US01 Sorial No.: Unknown Title: MATCHING SEMICONDUCTOR CIRCUITS Micron Docket No. 2012-0098.00/US Filling Date: Herewith Page 3 of 3

IN TESTIMONY WHEREOF, I have	e hereunto set my hand this <u>21</u> day of <u>√0√2713ER</u> 2012
	Andrea Marmiroli
WITNESS:	•
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(Date) 100 22 4012	
WITNESS:	45
Feberico Pio	Feducation
Printed Name	Signature
November 22, 2012	

PATENT REEL: 029366 FRAME: 0494

RECORDED: 11/28/2012

(Date)